

POWERTIP TECH. CORP.

DISPLAY DEVICES FOR BETTER ELECTRONIC DESIGN

Specification For Approval

Customer		:					
Model Type		: LCD	MODULE				
Sample Code		:					
Mass Product	ion Code	: PE160160BRF-001HP1					
Revision		: _0	_				
Customer Sign	Sales Sign	Checked By (QA)	Approved By	Prepared	By		

Revision Record

Date(y/m/d)	Rev.	Description	Note	Page
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1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	160 * 160 Dots
LCD Type	FSTN, Transflective, Positive
Driver Connation	1/160 Duty , 1/12 Bias
Viewing Direction	6 O' clock
Backlight	EL B/L
Weight	60g
Interface	4 bits parallel data input , without controller IC
Other	Extended Temp., External positive voltage

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	70.2 (L) * 89.5 (W) * 10.2 (H)(Max)	mm
Viewing Area	60.98 (L) * 80.9 (W)	mm
Active Area	55.985 (L) * 55.985 (W)	mm
Dot Size	0.335 (L) * 0.335 (W)	mm
Dot Pitch	0.35 (L) * 0.35 (W)	mm

Note: Other spec please refer to module drawing.

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	Vdd	-	-0.3	7.0	V
LCD Driver Supply Voltage	+Vee - Vss	-	-0.3	+25.0	V
Input Voltage	V_{IN}	-	-0.3	V _{DD} +0.3	V
Operating Temperature	T_{OP}	Touch panel and	-20	70	°C
Storage Temperature.	T _{ST}	EL B/L excluded	-30	80	°C
Humidity	H _D	-	20	90	%RH

1.4 DC Electrical Characteristics

 $Vdd = 5.0V\pm0.5V$, Vss = 0V , Ta = 25°C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	Vdd	-	4.5	5.0	5.5	V
"H" Input Voltage	V _{IH}	-	0.8 Vdd	1		V
"L" Input Voltage	V_{IL}	-		1	0.2 Vdd	V
"H" Output Voltage	V _{OH}	-	Vdd-0.4	-		V
"L" Output Voltage	V _{OL}	-		-	+0.4	V
	ldd	Vdd = 5.0 V	-	0.1	0.5	mΛ
Supply Current	lop	+Vee-Vss=19.1V		1.6	3.5	mA
LCM Driver Voltage		+Vee-Vss (-20°C)	20.2	20.4	20.6	
	V_{OP}	+Vee-Vss (25°C)	18.9	19.1	19.3	V
		+Vee-Vss (70°C)	16.9	17.1	17.3	

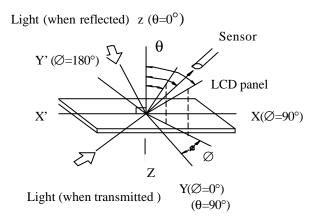
1.5 Optical Characteristics

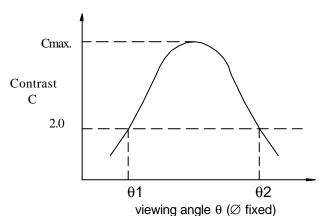
1/160 Duty, 1/12 Bias, $V_{OPR} = 19.1 \text{V}$, $Ta = 25^{\circ}\text{C}$

Item	Symbol	Conditions	Min.	Тур.	Max.	Reference
View Angle	θ	C <u>≥</u> 2.0,Ø=0°	-40°	ı	40°	Notes 1 & 2
Contrast Ratio	С	θ= 5°, Ø= 0°	2	5	ı	Note 3
Response Time(rise)	tr	θ= 5°, Ø= 0°	-	200 ms	400 ms	Note 4
Response Time(fall)	tf	θ= 5°, Ø= 0°	-	200 ms	400 ms	Note 4

Note 1: Definition of angles θ and \emptyset

Note 2: Definition of viewing angles $\theta 1$ and $\theta 2$





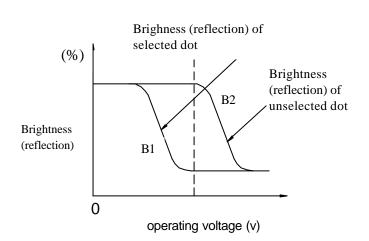
Note: Optimum viewing angle with the naked eye and viewing angle θ at Cmax. Above are not always the same

Note 4: Definition of response time

Note 3: Definition of contrast C

Brightness (reflection) of unselected dot (B2)

Brightness (reflection) of selected dot (B1)



VOP

VOP

Non-selected state | Non-selected state |

Contrast | 90% |

10% | Time

Note: Measured with a transmissive LCD panel which is displayed 1 cm²

 V_{OPR} : Operating voltage f_{FRM} : Frame frequency t_r : Response time (rise) t_f : Response time (fall)

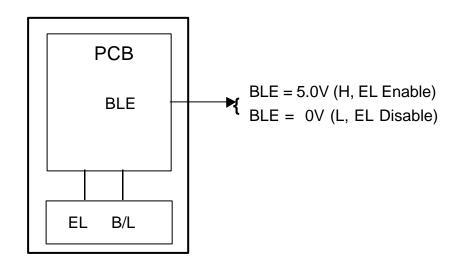
1.6 Backlight Characteristics

LCD Module with EL Backlight(Include Inverter)

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Inverter input Voltage	Vii	Vdd-Vss	4.5	5.0	5.5	V
Inverter output Voltage	Vio	Vii=5V	130	170	210	Vp-p
Inverter output Frequency	Fi	Vii=5V	160	210	260	Hz
Supply current	lii	Vii=5V	28	33	38	mA
Luminous Intensity	IV	With LCD	1	2		cd/m
Operating Temperature	T_OP		-35		50	°C
Storage Temperature.	T _{ST}		-40		60	°C
Storage Humidity	H _{ST}			70		%RH
Color	Blue-Green					

EL B/L Circuit



1.7 Touch Screen Characteristic

- Input Method and Activation Force
 Stylus 10~40 grams and Finger 20~40 grams
- Typical Optical CharacteristicsVisible Light Transmission: >78%@550nm
- 3. Electrical Specifications
 - 1. Operating resistance <2K
 - 2. Circuit close resistance X: 300~1000 Y: 150~800
 - 3. Circuit open resistance > 20M at 25V DC
 - 4. Linear Test Specification: +/- 1.5% (maximum)
 - 5. Surface Hardness PET 3H
- 4. Linearity Tolerance: 1.5% (maximum)
- 5. Environment Specification

Operating Temperature 0°C ~ +50°C (Humidity less than 85% RH)

Storage Temperature -20°C ~ +70°C (at ambient Humidity)

2. MODULE STRUCTURE

2.1 Counter Drawing

* See Appendix

2.2 Interface Pin Description

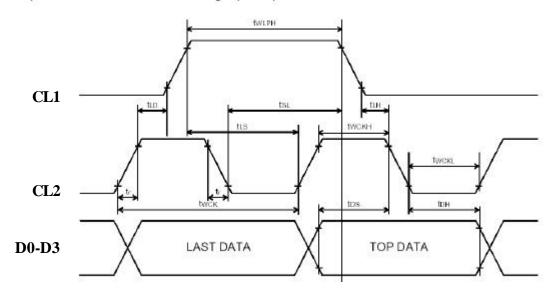
Pin No.	Symbol	Function
1	Vss	Signal ground
2	FLM	Frame signal
3	CL1	Display data latch
4	CL2	Display data shift
5	М	AC signal
6	Vdd	Power supply for logic
7	BLE	H: EL Enable L: EL Disable
8	+Vee	LCD drive Supply voltage (+Vee-Vss = 25V max)
9	D3	Display data
10	D2	Display data
11	D1	Display data
12	D0	Display data
13	TP_L	Connection to Left side of Touch Panel
14	TP_U	Connection to Up side of Touch Panel
15	TP_R	Connection to Right side of Touch Panel
16	TP_D	Connection to Down side of Touch Panel
17	Vss	Signal ground
18	Vss	Signal ground

2.3 Timing Characteristics

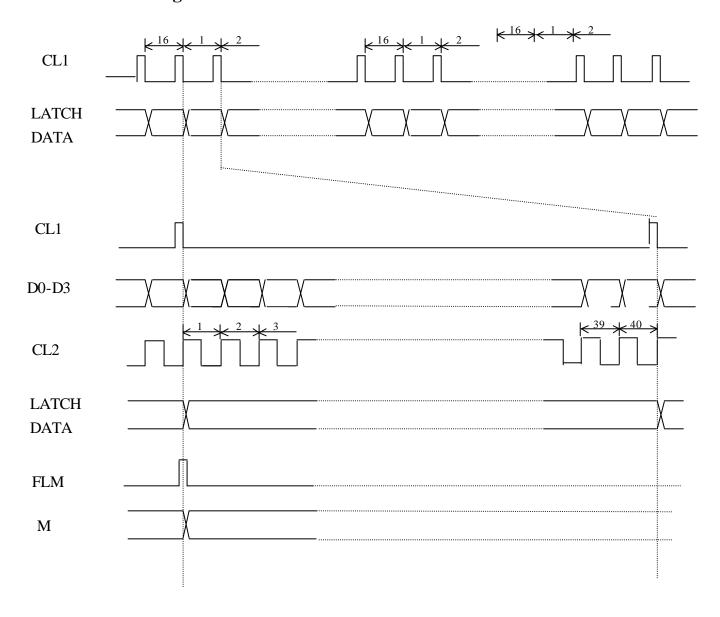
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Shift clock period	twck	125	19		ns	tr, tf ≦ 11ns, Note 1
Shift clock "H" pulse width	twckh	51	182		ns	
Shift clock "L" pulse width	twckL	51	-		ns	
Data setup time	tos	30	19		ns	
Data hole time	tрн	40	ri e		ns	
Latch pulse "H" pulse width	twlph	51			ns	
Shift clock rise to Latch pulse rise time	tro	0	97		ns	
Shift clock fall to Latch pulse fall time	tsı	51			ns	
Latch pulse rise to Shift clock rise time	tLS	51	-		ns	
Latch pulse fall to Shift clock fall time	tLH	51	-		ns	
Input signal rise time	tr		32	50	ns	Note 2
Input signal fall time	tr		- 12	50	ns	Note 2
Enable setup time	ts	36			ns	
Output delay time (1)	tp			78	ns	CL = 15pF
Output delay time (2)	tpd1, tpd2		(*)	1.2	μs	CL = 15pF
Output delay time (3)	tpd3		190	1.2	μS	CL = 15pF

Note

- 1. Take the cascade connection into consideration.
- 2. (tck twckii twckl.)/2 is the maximum in the case of high speed operation.

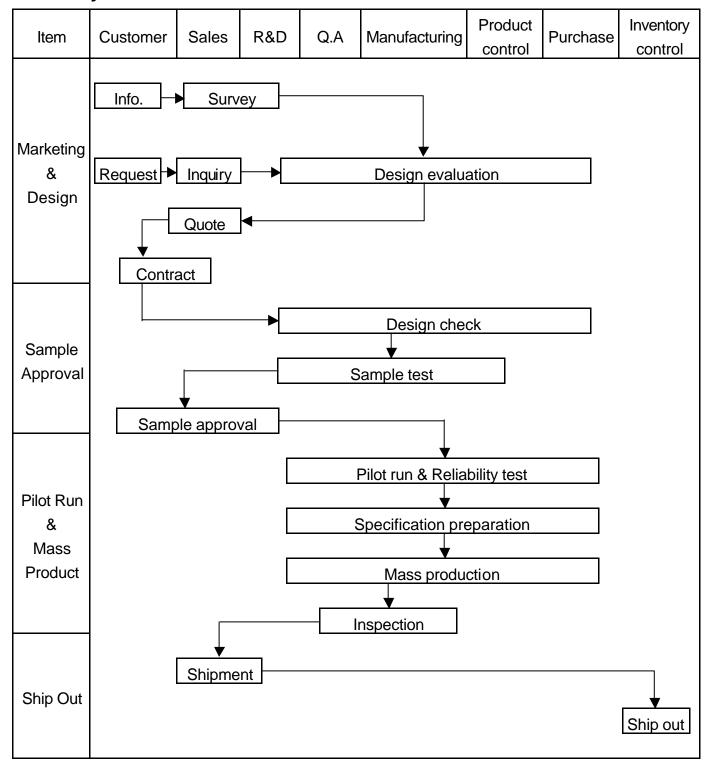


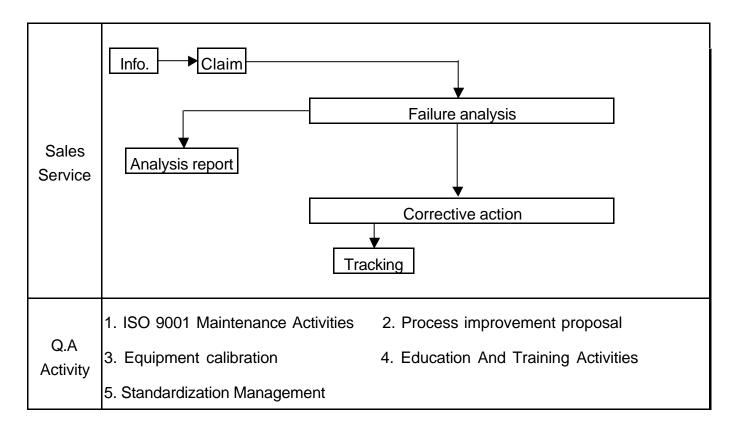
2.4 Interface Timing



3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





3.2 Inspection Specification

Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level

Equipment : Gauge、MIL-STD、Powertip Tester、Sample。

IQC Defect Level: Major Defect AQL 0.65; Minor Defect AQL 1.0。

FQC Defect Level: 100% Inspection.
OUT Going Defect Level: Sampling.

Specification:

NO	Item	Specification	Judge	Level
1	Part Number	Inconsistent with the P/N on the flow chart of production	N.G.	Major
2	Quantity	Inconsistent Q'TY with the flow chart of production	N.G.	Major
	Flantonia	Display short	N.G.	Major
	Electronic	Missing line	N.G.	Major
3	characteristics	Dot missing A > 1/2 Dot size	N.G.	Major
	A=(L + W) ÷ 2	No function	N.G.	Major
	71-(L 1 VV) - 2	Out put data error	N.G.	Major
		Material difference with flow chart	N.G.	Major
		LCD Assembled in opposite direction	N.G.	Major
	Appearance	Bezel assembled in opposite direction	N.G.	Major
	A=(L + W) ÷ 2	Shadow within LCD V./A + 1.0 mm	N.G.	Major
4	Λ-(L + VV) + Z	Dirty particle A > 0.4 mm	N.G.	Minor
4	Dirty particle (Include scratch、bubble)	Dirty particle length > 3.0mm And 0.01mm < Width 0.05mm (Width > 0.05mm Measure by area)	N.G.	Minor
	Sciatory bubble)	Without protective film	N.G.	Minor
		Conductive rubber over bezel	N.G.	Minor
		Burned PCB	N.G.	Major
		Green paint stripped & visible circuit A > 1.0mm (Finish coat not counted in)	N.G.	Minor
	PCB Appearance	A particle across the circuit	N.G	Minor
5		Circuit split > 1/2 Circuit width	N.G	Minor
	A=(L + W) ÷ 2	Any circuit risen	N.G	Minor
		0.2mm < Tin ball area A 0.4mm And Q'TY > 4 Pieces	N.G	Minor
		Tin ball area A > 0.4mm	N.G	Minor

NO	Item	Specification	Judge	Level
		Too soft: Shape by touch changed	N.G.	Major
Molding		Insufficient epoxy: IC circuit or IC pad visible	N.G.	Minor
6	appearance A=(L + W) ÷ 2	Excessive epoxy: Diameter > 20mm Or High > 2.5mm	N.G.	Minor
		Pin hole through to IC and A > 0.2mm	N.G.	Minor
		Angle between frame and TAB > 45 +10	N.G.	Minor
7	Bezel appearance	Electroplate strip A > 1.0mm (Top view only)	N.G.	Minor
7	A=(L + W) ÷ 2	Rust (Top view only)	N.G.	Minor
		Crack	N.G.	Minor
	David Palacata and	Error backlight color	N.G.	Major
	Backlight electric	No function	N.G.	Major
8	characteristics	Any LED dot no function	N.G.	Major
	A=(L + W) ÷ 2	PIN soldering without tin A > 1/2 solder pad	N.G.	Minor
	/_(L \ \\	Solder PIN high > 1.5mm	N.G.	Minor
9	LCD Appearance A=(L + W) ÷ 2	Polarize rise over V/A	N.G.	Minor
		Components mark unclearly	N.G.	Minor
		Components' distance more than 0.7mm firm the PCB	N.G.	Minor
10	Assembly parts A=(L+W)÷2	Error position ,not in center D > 1/4W W D D D Pad	N.G.	Minor
		Non- solder area > Twice solder area	N.G.	Minor
		Flux area A > 1/4 solder area	N.G.	Minor
		Component broken	N.G.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition

NO	Item	Test Co	ondition	Applicable Standard
1	High Temperature Storage	Storage At 80 ± 2 96~100 hrs Surrounding Temperature, Then Storage At Normal Condition 4hrs.		MIL-202E
2	Low Temperature Storage	Storage At -30 ± 2 96~100 hrs Surrounding Temperature, Then Storage At Normal Condition 4hrs.		MIL-202E
3	High Temperature Humidity Storage	1.Storage 96~100 hrs 60 ± 2 , 90~95%RH Surrounding Temperature, Then Storage At Normal Condition 4hrs .(Polarizer may fail in this environment). or 2.Storage 96~100 hrs 40 ± 2 , 90~95%RH Surrounding Temperature, Then Storage At Normal Condition 4 hrs.		MIL-202E
4	Temperature Cycling	-20 25 70 25 (30Mins) (5Mins) (30Mins) (5Mins) 10 Cycle		MIL-202E
5	Vibration	10~55Hz (1 Minute) 1.5mm X,Y And Z Direction * (Each 2hrs)		MIL-202E
6	Drop Test	Packing Weight (Kg) 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454	Drop High (Cm) 122 76 61 46	MIL-810E

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock, which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25 ± 5 and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

